





N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = 25°C
20V	0.55Ω @ V _{GS} = 4.5V	630mA
	0.9Ω @ V _{GS} = 1.8V	410mA

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

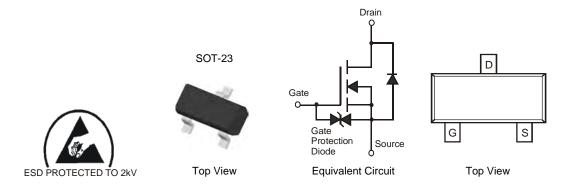
- DC-DC Converters
- Power management functions

Features and Benefits

- Low On-Resistance: $R_{DS(ON)} = 550_{(max)} m\Omega$ @ $V_{GS} = 4.5 V$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected up to 2KV
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe.
 Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.008 grams (approximate)



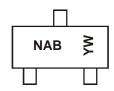
Ordering Information (Note 3)

Part Number	Case	Packaging
DMN2004K-7	SOT-23	3000/Tape & Reel

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



NAB = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code Key

Year	200	6	2007		2008	20	09	2010		2011	2	2012
Code	Т		U		V	V	V	Χ		Υ		Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characte	ristic		Symbol	Value	Units
Drain-Source Voltage		V_{DSS}	20	V	
Gate-Source Voltage		V _{GSS}	±8	V	
Drain Current (Note 4) V _{GS} = 4.5V	Steady State	$T_A = 25$ °C $T_A = 85$ °C	I _D	630 450	mA
Drain Current (Note 4) V _{GS} = 1.8V	Steady State	T _A = 25°C T _A = 85°C	I _D	410 300	mA
Pulsed Drain Current (Note 5)			I _{DM}	1.5	Α

Thermal Characteristics @TA = 25°C unless otherwise specified

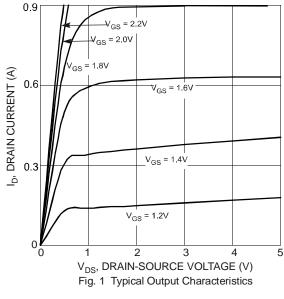
Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	P_D	350	mW
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	357	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-65 to +150	°C

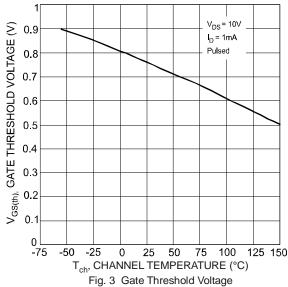
Electrical Characteristics @TA = 25°C unless otherwise specified

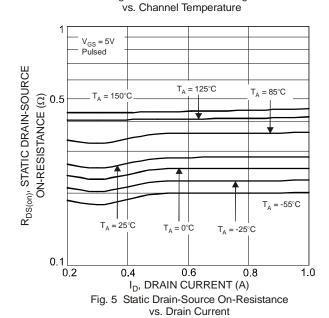
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	20	_		V	$V_{GS} = 0V, I_D = 10\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	V _{DS} = 16V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±1	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V _{GS(th)}	0.5	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			0.4	0.55		$V_{GS} = 4.5V, I_D = 540mA$
Static Drain-Source On-Resistance	R _{DS (ON)}	_	0.5	0.70	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			0.7	0.9		V _{GS} = 1.8V, I _D = 350mA
Forward Transfer Admittance	Y _{fs}	200	_	_	ms	V _{DS} =10V, I _D = 0.2A
Source Current	I _S	_	_	0.5	Α	_
Diode Forward Voltage (Note 6)	V _{SD}	0.6	_	1	V	V _{GS} = 0V, I _S = 500mA
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}	_	_	150	pF	101/11/
Output Capacitance	Coss	_	_	25	pF	$V_{DS} = 16V, V_{GS} = 0V$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_		20	pF	1 = 1.0WHZ
Gate Resistance	Rg	_	292		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
Total Gate Charge	Qg	_	0.9	_		
Gate-Source Charge	Q _{gs}	_	0.2	_	nC	$V_{DS} = 15V$, $V_{GS} = 4.5V$, $I_{D} = 0.5A$
Gate-Drain Charge	Q_{gd}	_	0.2	_		
Turn-On Delay Time	t _{D(on)}	_	5.7	_		
Turn-On Rise Time	t _r	_	8.4	_	200	$V_{GS} = 8V, V_{DS} = 15V,$
Turn-Off Delay Time	t _{D(off)}	_	59.4	_	ns	$R_G = 6\Omega$, $R_L = 30\Omega$
Turn-Off Fall Time	t _f	_	37.6	_		
Body Diode Reverse Recovery Time	t _{rr}	_	5.5	_	ns	$I_S = 0.5A$, $dI/dt = -100A/\mu s$
Body Diode Reverse Recovery Charge	Q _{rr}	_	0.85	_	nC	$I_S = 0.5A$, $dI/dt = -100A/\mu s$

4. Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.
5. Pulse width ≤10μS, Duty Cycle ≤1%.
6. Short duration pulse test used to minimize self-heating effect. Notes:









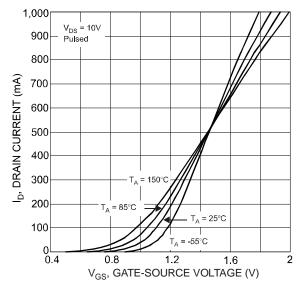


Fig. 2 Reverse Drain Current vs. Source-Drain Voltage

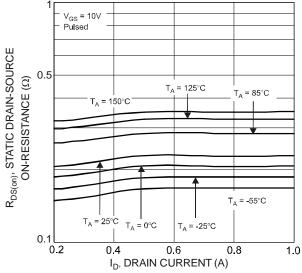


Fig. 4 Static Drain-Source On-Resistance vs. Drain Current

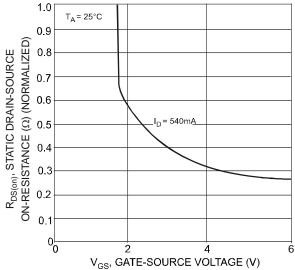


Fig. 6 Static Drain-Source, On-Resistance vs. Gate-Source Voltage



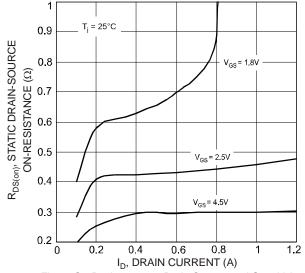
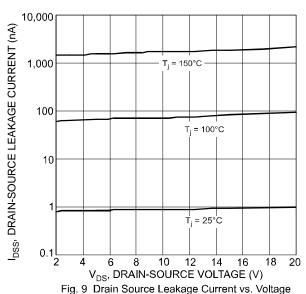


Fig. 7 On-Resistance vs. Drain Current and Gate Voltage



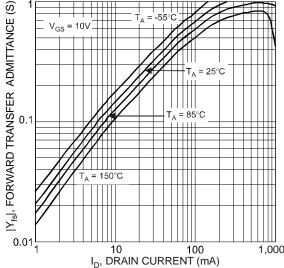


Fig. 11 Forward Transfer Admittance vs. Drain Current

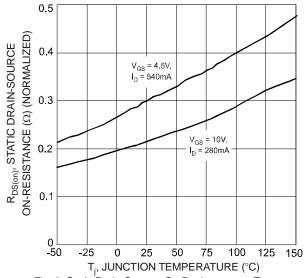


Fig. 8 Static Drain-Source, On-Resistance vs. Temperature

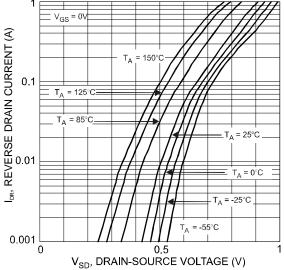
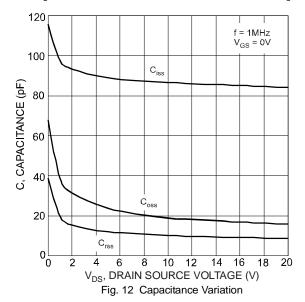
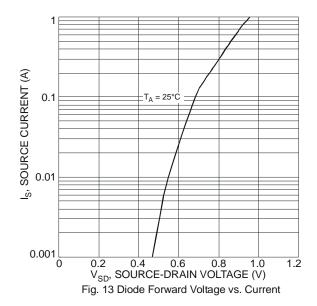
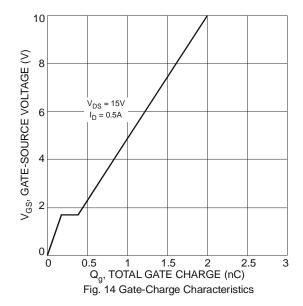


Fig. 10 Reverse Drain Current vs. Source-Drain Voltage

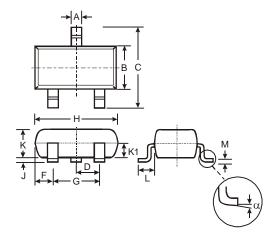






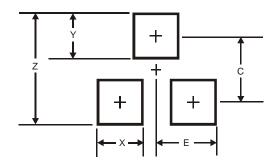


Package Outline Dimensions



SOT-23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.903	1.10	1.00					
K1	-	-	0.400					
L	0.45	0.61	0.55					
M	0.085	0.18	0.11					
α	0°	8°	-					
All Dimensions in mm								

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35



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